Ref #	Hits	Search Query	DBs	Default Operat or	Plura Is	Time Stamp
L6	47	("2544646" "2767973" "2793028" "2947067" "3226981" "3382724" "3382724" "3710629" "3713088" "3739202" "3744322" "3813505" "3842681" "3859847" "3897690" "3897997" "3902374" "3924475" "4091679" "4104920" "4155257" "4199990" "4221131" "4258577" "4281384" "4311046" "4342227" "4345474" "4445376" "4483194" "44510802" "4512192" "4533100" "4590801") PN.	US-P.GP UB; USPAT; USOCR	OR	OFF	2005/07/19 08:34
L7	. 5	6 and silicon	US-PGP UB; USPAT; USOCR	OR	OFF	2005/07/19 08:35
L8	4	flexible adj silicon adj substrate	US-PGP UB; USPAT; USOGR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/07/19 08:45
L9	486	flexible adj substrate with silicon	US-PGP UB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/07/19 09:38

L11	54	"5531002" or "5406848" or "5421213"	US-PGP UB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2005/07/19 09:09
L12	35	11 and groove	US-PGP UB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2005/07/19 09:09
L13	290	9 and @pd>"20010515" not okada	US-PGP UB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/07/19 09:38
L14	46	"5808198" or "5490421" or "3860949" or "4984063"	US-PGP UB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/07/19 09:57
L15	19	14 and flex\$5 and silicon	US-PGP UB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/07/19 09:57

L16	358	vibration adj sensor and groove	US-PGP UB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/07/19 09:58
L17	131383	silicon adj substrate	US-PGP UB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/07/19 09:58
L18	22	L16 and L17	US-PGP UB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/07/19 09:58
L22	232	((bend bending bended) near4 stress and silicon and (groove trench) and (bond bonded bonding)) not (((bend bending bended) near4 stress and silicon and (groove trench) and (bond bonded bonding)) and ceramic)	US-PGP UB; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/07/19 09:59
L23	349	(257/668,669,674,738). CCLS. and @pd>"20040912"	US-PGP UB; USPAT	OR	OFF	2005/07/19 09:59
L24	125	((bend bending bended) near4 stress and silicon and (groove trench) and (bond bonded bonding)) and ceramic	US-PGP UB; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/07/19 09:59

L26	357	(bend bending bended) near4 stress and silicon and (groove trench) and (bond bonded bonding)	US-PGP UB; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/07/19 09:59
L27	1625	((bend bending bended) and silicon and (groove trench) and (bond bonded bonding)) and ceramic	US-PGP UB; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/07/19 09:59
L28	8088	(bend bending bended) and silicon and (groove trench)	US-PGP UB; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/07/19 09:59
L29	4428	(bend bending bended) and silicon and (groove trench) and (bond bonded bonding)	US-PGP UB; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/07/19 09:59
L30	4	US-5808198-\$ or US-5490421-\$ or JP-11148946-\$ or JP-09304424-\$	USPAT; JPO	OR	OFF	2005/07/19 09:59
S17	6	(US-5428259-\$ or US-4905575-\$ or US-4691568-\$ or US-5912427-\$).did. or (US-20020185715-\$ or US-20010012035-\$).did.	US-PGP UB; USPAT	OR	OFF	2004/09/12 15:10
S63	4	(US-4691568-\$ or US-5391501-\$ or US-20010049959-\$ or US-20020185715-\$).did.	US-PGP UB; USPAT	OR	OFF	2005/07/18 19:42